



TDK Corporation
Flash Memory Applied Device Business

2-15-7, Higashi-Ohwada, Ichikawa-shi,
Chiba, Japan

Product Change Notice

TDK PCN: AC-128-003-002-0

Date: June. 12th, 2023

To: TCA Distributor

Type of Change:

Mold renewal of SSD resin housing

Title of Change

SSD with resin housing (SDE9D series)

Description of Change:

Changed the insert nut and its installation method with the mold renewal for the resin housing of the SSD.

***Current:**

Heat press-fit the insert nut after molding the housing



Current insert nut

***New:**

Molding the housing after installing the insert nut



New insert nut

In this change, there is no change in the housing dimension specification.
And there is no change in the material and appearance of the housing.



Current SSD housing



New SSD housing

Reasons for Change

This is a renewal due to aging of the housing mold.

Changes to the insert nut and installation method will be implemented to further improve the processing quality of the insert nut.

Product Affected:

| TDK Product Number | Affected Customer Product Number |
|----------------------|----------------------------------|
| SDE9D001GTNAWB00ESA0 | SDE9D001GTNAWB00ESA0 |
| SDE9D002GTNBWB00ESA0 | SDE9D002GTNBWB00ESA0 |
| SDE9D004GTNBWB00ESA0 | SDE9D004GTNBWB00ESA0 |
| SDE9D008GTYBCB00ESA0 | SDE9D008GTYBCB00ESA0 |
| SDE9D008GTYBWB00ESA0 | SDE9D008GTYBWB00ESA0 |
| SDE9D016GTYBWB00ESA0 | SDE9D016GTYBWB00ESA0 |
| SDE9D032GTYBWB00ESA0 | SDE9D032GTYBWB00ESA0 |
| SDE9D064GTYBWB00ESA0 | SDE9D064GTYBWB00ESA0 |

Date Availability

Regarding the SSD of the target products, it will be applied sequentially as soon as the current housing is exhausted. (Running change is planned after December 2023 production)

Contact Information

TDK Corporation

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